HT1660

96×32 LCD Controller for I/O MCU

PATENTED

PAT No. : 099352

Technical Document

- Tools Information
- FAQs
- Application Note

Features

- Operating voltage: 2.7V~5.2V
- Built-in 32kHz RC oscillator
- External 32.768kHz crystal oscillator or 32kHz frequency source input
- Standby current: <1μA at 3V, <2μA at 5V
- Internal resistor type: 1/6 bias or 1/5 bias, 1/32 duty, or 1/16 duty
- Three selectable LCD frame frequencies: 64Hz, 89Hz or 170Hz
- Max. 96×32 patterns, 96 segments and 32 commons
- 112 segments and 16 commons selectable by command method
- Built-in bit-map display RAM: 3072 bits (=96×32 bits)
- Built-in internal resistor type bias generator
- Six-wire interface (four data wires)
- Eight kinds of time base/WDT selection
- Time base or WDT overflow output
- R/W address auto increment
- Built-in buzzer driver (2kHz/4kHz)
- Power down command reduces power consumption
- Software configuration feature
- Data mode and Command mode instructions
- Three data accessing modes
- Provides VLCD pin to adjust LCD operating voltage and max. VLCD voltage up to 7V
- Provides three kinds of bias current programming
- Control of TN-type and STN-type LCDs
- 208-pin QFP package

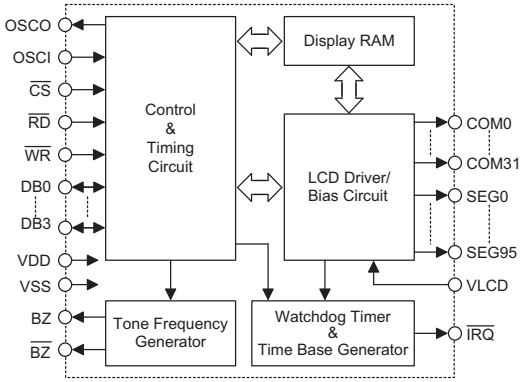
Applications

- Leisure products
- Games
- Personal digital assistant
- Cellular phone
- Global positioning system
- Consumer electronics

General Description

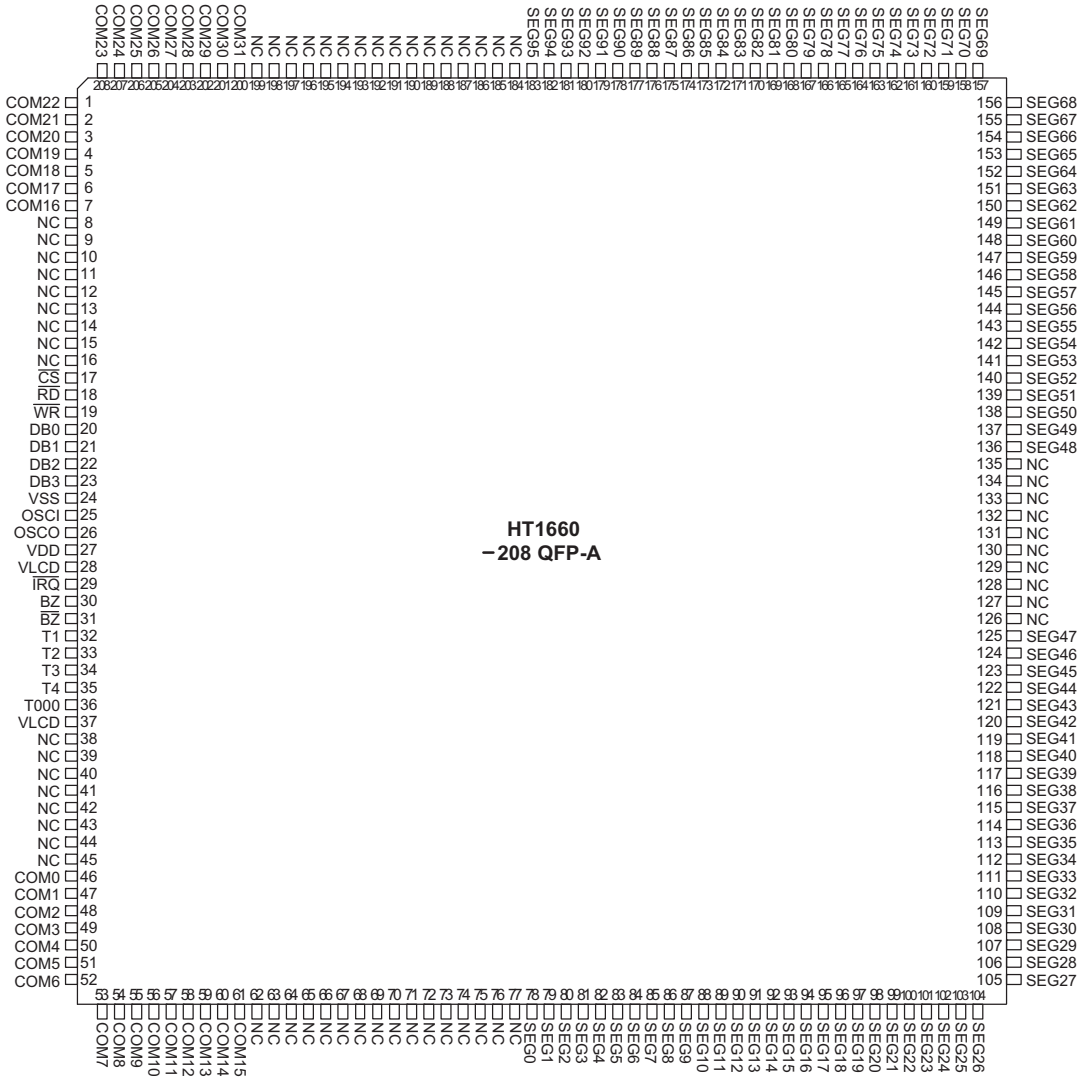
HT1660 is a peripheral device specially designed for I/O type MCU used to expand the display capability. The max. display segment of the device are 3072 patterns (96 segments and 32 commons). It also supports four data bits interface, buzzer sound, Watchdog Timer or time base timer functions. The HT1660 is a memory mapping and multi-function LCD controller. Since the HT1660 can control TN-type (Twisted Nematic) or STN-type (Super Twisted Nematic) LCDs. The software configuration feature of the HT1660 make it suitable for multiple LCD applications including LCD modules and display subsystems. Only six lines ($\overline{CS}$, $\overline{WR}$, DB0~DB3) are required for the interface between the host controller and the HT1660.

Block Diagram

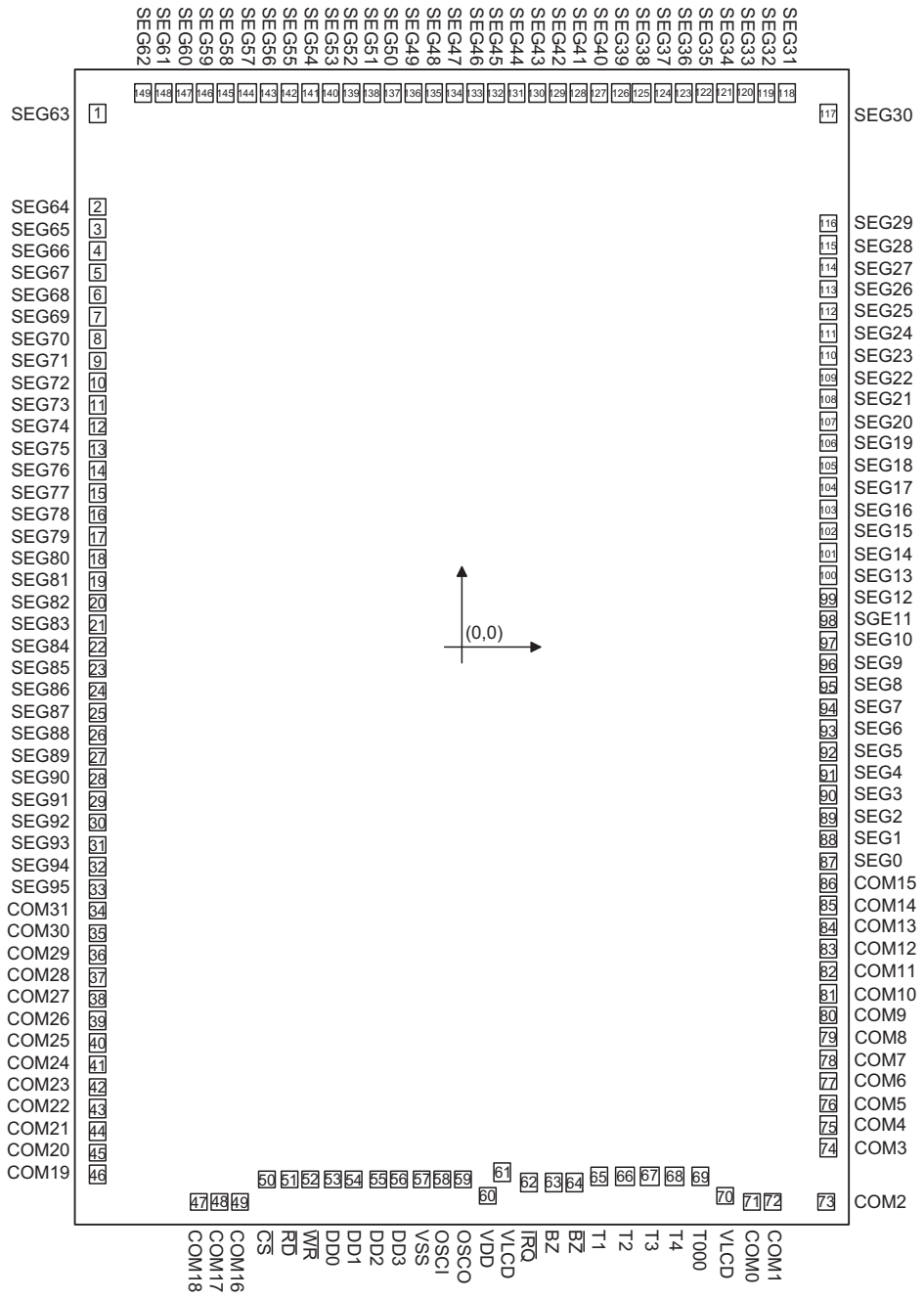


Note: CS: Chip selection
BZ, BZ: Tone outputs
WR, RD: WRITE clock, READ clock
DB0~DB3: Data bus
COM0~COM31, SEG0~SEG95: LCD outputs
IRQ: Time base or WDT overflow output

Pin Assignment



Pad Assignment



Chip size: 3555×5000 (μm)^2

* The IC substrate should be connected to VSS in the PCB layout artwork.

Pad Coordinates

Unit: μm

Pad No.	X	Y	Pad No.	X	Y	Pad No.	X	Y
1	−1672.500	2305.000	51	−789.900	−2299.900	101	1672.500	405.900
2	−1672.500	1901.700	52	−694.900	−2299.900	102	1672.500	500.900
3	−1672.500	1806.700	53	−589.300	−2299.900	103	1672.500	595.900
4	−1672.500	1711.700	54	−494.300	−2299.900	104	1672.500	690.900
5	−1672.500	1616.700	55	−388.700	−2299.900	105	1672.500	785.900
6	−1672.500	1521.700	56	−293.700	−2299.900	106	1672.500	880.900
7	−1672.500	1426.700	57	−190.500	−2299.900	107	1672.500	975.900
8	−1672.500	1331.700	58	−95.000	−2299.900	108	1672.500	1070.900
9	−1672.500	1236.700	59	5.300	−2299.900	109	1672.500	1165.900
10	−1672.500	1141.700	60	111.400	−2368.850	110	1672.500	1260.900
11	−1672.500	1046.700	61	185.650	−2268.850	111	1672.500	1355.900
12	−1672.500	951.700	62	308.850	−2309.400	112	1672.500	1450.900
13	−1672.500	856.700	63	414.450	−2309.400	113	1672.500	1545.900
14	−1672.500	761.700	64	509.450	−2309.400	114	1672.500	1640.900
15	−1672.500	666.700	65	630.250	−2285.250	115	1672.500	1735.900
16	−1672.500	571.700	66	743.850	−2285.250	116	1672.500	1830.900
17	−1672.500	476.700	67	857.450	−2285.250	117	1672.500	2305.000
18	−1672.500	381.700	68	971.050	−2285.250	118	1484.800	2395.000
19	−1672.500	286.700	69	1084.650	−2285.250	119	1389.800	2395.000
20	−1672.500	191.700	70	1201.050	−2368.850	120	1294.800	2395.000
21	−1672.500	96.700	71	1323.050	−2395.000	121	1199.800	2395.000
22	−1672.500	1.700	72	1419.550	−2395.000	122	1104.800	2395.000
23	−1672.500	−93.300	73	1666.450	−2395.000	123	1009.800	2395.000
24	−1672.500	−188.300	74	1672.500	−2159.100	124	914.800	2395.000
25	−1672.500	−283.300	75	1672.500	−2064.100	125	819.800	2395.000
26	−1672.500	−378.300	76	1672.500	−1969.100	126	724.800	2395.000
27	−1672.500	−473.300	77	1672.500	−1874.100	127	629.800	2395.000
28	−1672.500	−568.300	78	1672.500	−1779.100	128	534.800	2395.000
29	−1672.500	−663.300	79	1672.500	−1684.100	129	439.800	2395.000
30	−1672.500	−758.300	80	1672.500	−1589.100	130	344.800	2395.000
31	−1672.500	−853.300	81	1672.500	−1494.100	131	249.800	2395.000
32	−1672.500	−948.300	82	1672.500	−1399.100	132	154.800	2395.000
33	−1672.500	−1043.300	83	1672.500	−1304.100	133	59.800	2395.000
34	−1672.500	−1138.300	84	1672.500	−1209.100	134	−35.200	2395.000
35	−1672.500	−1233.300	85	1672.500	−1114.100	135	−130.200	2395.000
36	−1672.500	−1328.300	86	1672.500	−1019.100	136	−225.200	2395.000
37	−1672.500	−1423.300	87	1672.500	−924.100	137	−320.200	2395.000
38	−1672.500	−1518.300	88	1672.500	−829.100	138	−415.200	2395.000
39	−1672.500	−1613.300	89	1672.500	−734.100	139	−510.200	2395.000
40	−1672.500	−1708.300	90	1672.500	−639.100	140	−605.200	2395.000
41	−1672.500	−1803.300	91	1672.500	−544.100	141	−700.200	2395.000
42	−1672.500	−1898.300	92	1672.500	−449.100	142	−795.200	2395.000
43	−1672.500	−1993.300	93	1672.500	−354.100	143	−890.200	2395.000
44	−1672.500	−2088.300	94	1672.500	−259.100	144	−985.200	2395.000
45	−1672.500	−2183.300	95	1672.500	−164.100	145	−1080.200	2395.000
46	−1672.500	−2278.300	96	1672.500	−69.100	146	−1175.200	2395.000
47	−1208.250	−2395.000	97	1672.500	25.900	147	−1270.200	2395.000
48	−1113.250	−2395.000	98	1672.500	120.900	148	−1365.200	2395.000
49	−1018.250	−2395.000	99	1672.500	215.900	149	−1460.200	2395.000
50	−895.500	−2299.900	100	1672.500	310.900			

Pad Description

Pad No.	Pad Name	I/O	Description
1~33 87~149	SEG63~SEG95 SEG0~SEG62	O	LCD segment outputs
34~49 71~86	COM31~COM16 COM0~COM15	O	LCD common outputs, under 112×16 command mode, COM16~COM31 will share to SEG96~SEG111. COM31/SEG96, COM30/SEG97, COM29/SEG98....., COM18/SEG109, COM17/SEG110, COM16/SEG111
50	$\overline{CS}$	I	Chip selection input with pull-high resistor. When the $\overline{CS}$ is logic high, the data and command read from or write to the HT1660 are disabled. The serial interface circuit is also reset. But if the $\overline{CS}$ is at a logic low level and is input to the $\overline{CS}$ pad, the data and command transmission between the host controller and the HT1660 are all enabled.
51	$\overline{RD}$	I	READ clock input with pull-high resistor. Data in the RAM of the HT1660 are clocked out on the falling edge of the $\overline{RD}$ signal. The clocked out data will appear on the data line. The host controller can use the next rising edge to latch the clocked out data.
52	$\overline{WR}$	I	WRITE clock input with pull-high resistor. Data on the DATA line are latched into the HT1660 on the rising edge of the $\overline{WR}$ signal.
53~56	DB0~DB3	I/O	Parallel data input/output with a pull-high resistor
57	VSS	—	Negative power supply for logic circuit, ground
58 59	OSCI OSCO	I O	The OSCI and OSCO pads are connected to a 32.768kHz crystal in order to generate a system clock. If the system clock comes from an external clock source, the external clock source should be connected to the OSCI pad. But if an on-chip RC oscillator is selected, the OSCI and OSCO pads can be left open.
60	VDD	—	Positive power supply for logic circuit
61	VLCD	I	Power supply for LCD driver circuit
62	$\overline{IRQ}$	O	Time base or Watchdog Timer overflow flag, NMOS open drain output.
63, 64	BZ, $\overline{BZ}$	O	2kHz or 4kHz frequency output pair (tristate output buffer)
65~69	T1~T4, T000	I	Vary bias current pin It is usually not connected

Absolute Maximum Ratings

Supply Voltage ..... V_{SS}–0.3V to V_{SS}+5.5V

Input Voltage ..... V_{SS}–0.3V to V_{DD}+0.3V

Storage Temperature ..... –50°C to 125°C

Operating Temperature ..... –25°C to 75°C

Note: These are stress ratings only. Stresses exceeding the range specified under "Absolute Maximum Ratings" may cause substantial damage to the device. Functional operation of this device at other conditions beyond those listed in the specification is not implied and prolonged exposure to extreme conditions may affect device reliability.

D.C. Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
V_{DD}	Operating Voltage	—	—	2.7	—	5.2	V
I_{DD1}	Operating Current	3V	No load/LCD ON On-chip RC oscillator	—	150	250	μA
		5V		—	250	370	μA
I_{DD2}	Operating Current	3V	No load/LCD ON Crystal oscillator	—	135	200	μA
		5V		—	200	300	μA
I_{DD11}	Operating Current	3V	No load/LCD OFF On-chip RC oscillator	—	15	30	μA
		5V		—	50	70	μA
I_{DD22}	Operating Current	3V	No load/LCD OFF Crystal oscillator	—	2	10	μA
		5V		—	3	10	μA
I_{STB}	Standby Current	3V	No load, Power down mode	—	—	1	μA
		5V		—	—	2	μA
V_{IL}	Input Low Voltage	3V	DB0~DB3, $\overline{WR}$, $\overline{CS}$, $\overline{RD}$	0	—	0.6	V
		5V		0	—	1.0	V
V_{IH}	Input High Voltage	3V	DB0~DB3, $\overline{WR}$, $\overline{CS}$, $\overline{RD}$	2.4	—	3	V
		5V		4.0	—	5	V
I_{OL1}	BZ, $\overline{BZ}$, $\overline{IRQ}$ Sink Current	3V	V_{OL}=0.3V	1.2	2.5	—	mA
		5V	V_{OL}=0.5V	3	6	—	mA
I_{OH1}	BZ, $\overline{BZ}$ Source Current	3V	V_{OH}=2.7V	–0.9	–1.8	—	mA
		5V	V_{OH}=4.5V	–2	–4	—	mA
I_{OL2}	DB0~DB3 Sink Current	3V	V_{OL}=0.3V	1.2	2.5	—	mA
		5V	V_{OL}=0.5V	3	6	—	mA
I_{OH2}	DB0~DB3 Source Current	3V	V_{OH}=2.7V	–0.9	–1.8	—	mA
		5V	V_{OH}=4.5V	–2	–4	—	mA
I_{OL3}	LCD Common Sink Current	3V	V_{OL}=0.3V	80	160	—	μA
		5V	V_{OL}=0.5V	180	360	—	μA
I_{OH3}	LCD Common Source Current	3V	V_{OH}=2.7V	–40	–80	—	μA
		5V	V_{OH}=4.5V	–90	–180	—	μA
I_{OL4}	LCD Segment Sink Current	3V	V_{OL}=0.3V	50	100	—	μA
		5V	V_{OL}=0.5V	120	240	—	μA
I_{OH4}	LCD Segment Source Current	3V	V_{OH}=2.7V	–30	–60	—	μA
		5V	V_{OH}=4.5V	–70	–140	—	μA
R_{PH}	Pull-high Resistor	3V	DB0~DB3, $\overline{WR}$, $\overline{CS}$, $\overline{RD}$	150	250	410	kΩ
		5V		60	125	210	kΩ

A.C. Characteristics

Ta=25°C

Symbol	Parameter	Test Conditions		Min.	Typ.	Max.	Unit
		V_{DD}	Conditions				
f_{SYS1}	System Clock	5V	On-chip RC oscillator	24	32	40	kHz
f_{SYS2}	System Clock	—	Crystal oscillator	—	32768	—	Hz
f_{SYS3}	System Clock	—	External clock source	—	32768	—	Hz
f_{LCD1}	LCD Frame Frequency	5V	On-chip RC oscillator	61/117	89/170	111/213	Hz
f_{LCD2}	LCD Frame Frequency	—	Crystal oscillator	—	64	—	Hz
f_{LCD3}	LCD Frame Frequency	—	External clock source	—	64	—	Hz
t_{COM}	LCD Common Period	—	n: Number of COM	—	n/f_{LCD}	—	sec
f_{CLK1}	4-Bit Data Clock ($\overline{WR}$ Pin)	3V	Duty cycle 50%	—	—	150	kHz
		5V		—	—	300	kHz
f_{CLK2}	4-Bit Data Clock ($\overline{RD}$ Pin)	3V	Duty cycle 50%	—	—	75	kHz
		5V		—	—	150	kHz
t_{CS}	4-Bit Interface Reset Pulse Width (Figure 3)	—	$\overline{CS}$	150	250	—	ns
t_{CLK}	$\overline{WR}$, $\overline{RD}$ Input Pulse Width (Figure 1)	3V	Write mode	3.34	—	—	μs
			Read mode	6.67			
		5V	Write mode	1.67	—	—	μs
			Read mode	3.34			
t_r, t_f	Rise/Fall Time Serial Data Clock Width (Figure 1)	—	—	—	120	160	ns
t_{su}	Setup Time for DB to $\overline{WR}$, $\overline{RD}$ Clock Width (Figure 2)	—	—	80	120	—	ns
t_h	Hold Time for DB to $\overline{WR}$, $\overline{RD}$ Clock Width (Figure 2)	—	—	60	120	—	ns
t_{su1}	Setup Time for $\overline{CS}$ to $\overline{WR}$, $\overline{RD}$ Clock Width (Figure 3)	—	—	50	100	—	ns
t_{h1}	Setup Time for $\overline{CS}$ to $\overline{WR}$, $\overline{RD}$ Clock Width (Figure 3)	—	—	50	100	—	ns
f_{tone2k}	Tone Frequency	5V	On-chip RC oscillator	1.5	2	2.5	kHz
f_{tone4k}	Tone Frequency	5V	On-chip RC oscillator	3	4	5	kHz

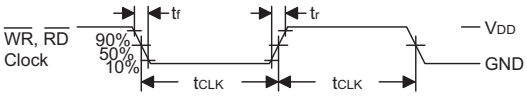


Figure 1

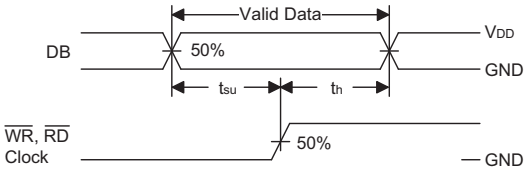


Figure 2

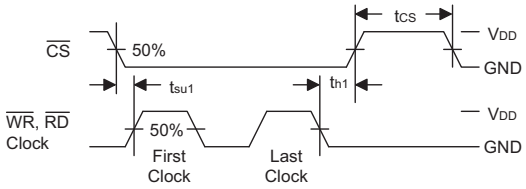


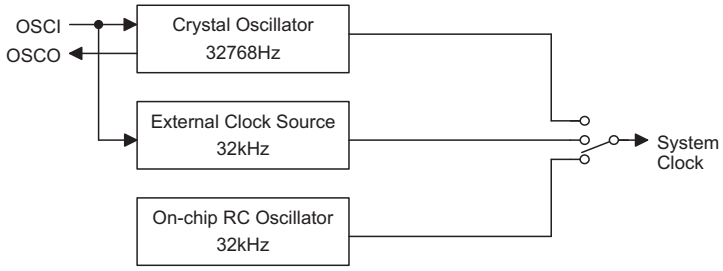
Figure 3

Functional Description

System Oscillator

The HT1660 system clock is used to generate the time base/Watchdog Timer (WDT) clock frequency, LCD driving clock, and tone frequency. The clock source may be from an on-chip RC oscillator (32kHz), a crystal oscillator (32.768kHz), or an external 32kHz clock by the S/W setting. The configuration of the system oscillator is as shown. After the SYS DIS command is executed, the system clock will stop and the LCD bias generator will turn off. That command is available only for the on-chip RC oscillator or for the crystal oscillator. Once the system clock stops, the LCD display will become blank, and the time base/WDT loses its function as well.

The LCD OFF command is used to turn the LCD bias generator off. After the LCD bias generator switches off by issuing the LCD OFF command, using the SYS DIS command reduces power consumption, thus serving as a system power down command. But if the external clock source is chosen as the system clock, using the SYS DIS command can neither turn the oscillator off nor carry out the power down mode. The crystal oscillator option can be applied to connect an external frequency source of 32kHz to the OSCI pin. In this case, the system fails to enter the power down mode, similar to the case in the external 32kHz clock source operation. At the initial system power on, the HT1660 is at the SYS DIS state.



System Oscillator Configuration

Display Memory – RAM Structure

The static display RAM is organized into 768×4 bits and stores the display data. The contents of the RAM are directly mapped to the contents of the LCD driver. Data in the RAM can be accessed by the READ, WRITE and READ-MODIFY-WRITE commands. The following is a mapping from the RAM to the LCD patterns.

	00H	08H	10H	18H	20H - - - - - - - - - 2D8H	2E0H	2E8H	2F0H	2F8H
COM0	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM1	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM2	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM3	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	01H	**09H**	**11H**	**19H**	**21H - - - - - - - - - 2D9H**	**2E1H**	**2E9H**	**2F1H**	**2F9H**
COM4	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM5	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM6	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM7	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	02H	**0AH**	**12H**	**1AH**	**22H- - - - - - - - - 2DAH**	**2E2H**	**2EAH**	**2F2H**	**2FAH**
COM8	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM9	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM10	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM11	Bit3	Bit3	Bit03				Bit3	Bit3	Bit3
	03H	**0BH**	**13H**	**1BH**	**23H- - - - - - - - - 2DBH**	**2E3H**	**2EBH**	**2F3H**	**2FBH**
COM12	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM13	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM14	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM15	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	04H	**0CH**	**14H**	**1CH**	**24H- - - - - - - - - 2DCH**	**2E4H**	**2ECH**	**2F4H**	**2FCH**
COM16	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM17	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM18	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM19	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	05H	**0DH**	**15H**	**1DH**	**25H- - - - - - - - - 2DDH**	**2E5H**	**2EDH**	**2F5H**	**2FDH**
COM20	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM21	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM22	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM23	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	06H	**0EH**	**16H**	**1EH**	**26H- - - - - - - - - 2DEH**	**2E6H**	**2EEH**	**2F6H**	**2FEH**
COM24	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM25	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM26	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM27	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	07H	**0FH**	**17H**	**1FH**	**27H - - - - - - - - - 2DFH**	**2E7H**	**2EFH**	**2F7H**	**2FFH**
COM28	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM29	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM30	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM31	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	SEG0	**SEG1**	**SEG2**	**SEG3**		**SEG92**	**SEG93**	**SEG94**	**SEG95**

96×32 Selection Mode RAM Mapping Table

	00H	04H	08H	0CH	10H- - - - - - - - - 1ACH	1B0H	1B4H	1B8H	1BCH
COM0	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM1	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM2	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM3	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	01H	**05H**	**09H**	**0DH**	**11H- - - - - - - - - 1ADH**	**1B1H**	**1B5H**	**1B9H**	**1BDH**
COM4	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM5	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM6	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM7	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	02H	**06H**	**0AH**	**0EH**	**12H- - - - - - - - - 1AEH**	**1B2H**	**1B6H**	**1BAH**	**1BEH**
COM8	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM9	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM10	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM11	Bit3	Bit3	Bit3s				Bit3	Bit3	Bit3
	03H	**07H**	**0BH**	**0FH**	**13H- - - - - - - - - 1AFH**	**1B3H**	**1B7H**	**1BBH**	**1BFH**
COM12	Bit0	Bit0	Bit0				Bit0	Bit0	Bit0
COM13	Bit1	Bit1	Bit1				Bit1	Bit1	Bit1
COM14	Bit2	Bit2	Bit2				Bit2	Bit2	Bit2
COM15	Bit3	Bit3	Bit3				Bit3	Bit3	Bit3
	SEG0	**SEG1**	**SEG2**	**SEG3**		**SEG108**	**SEG109**	**SEG110**	**SEG111**

112×16 Selection Mode RAM Mapping Table

Name	Command Code	Function
112×16 Mode	X**100**-0001-1111-XXXX	Change segment from 96 to 112 and common from 32 to 16
The default value after power ON reset is 96×32 mode, set "Normal" command will change 112×16 mode to 96×32 mode.		

Frame Frequency

HT1660 provides three kinds of frame frequency option by command code; 64Hz, 89Hz and 170Hz respectively. FRAME 64Hz provides 64Hz frame frequency. FRAME 89Hz provides 89Hz frame frequency. FRAME 170Hz provides 170Hz frame frequency.

Name	Command Code	Function
FRAME 170Hz	X**100**-0001-1000-XXXX	Select 170Hz frame frequency
FRAME 89Hz	X**100**-0001-1101-XXXX	Select 89Hz frame frequency
FRAME 64Hz	X**100**-0001-1110-XXXX	Select 64Hz frame frequency

Frame Frequency Selection Command Code

Time Base and Watchdog Timer – WDT

The time base generator and WDT share the same counter which is divided by 256. The $\overline{\text{IRQ}}$ clock can be programmed as 1Hz, 2Hz, ..., 128Hz output. TIMER DIS/EN/CLR, WDT DIS/EN/CLR and $\overline{\text{IRQ}}$ EN/DIS are independent from each other. Once the WDT time-out occurs, the $\overline{\text{IRQ}}$ pin will remain at a logic low level until the CLR WDT or the $\overline{\text{IRQ}}$ DIS command is issued.

If an external clock is selected as the system frequency source, the SYS DIS command turns out invalid and the power down mode fails to be carried out until the external clock source is removed.

Buzzer Tone Output

A simple tone generator is implemented in the HT1660. The tone generator can output a pair of differential driving signals on the BZ and $\overline{BZ}$ which are used to generate a single tone.

By executing the TONE 4K and TONE 2K commands there are two tone frequency outputs selectable that can turn on the tone output. The TONE 4K and TONE 2K commands set the tone frequency to 4kHz and 2kHz, respectively. The tone output can be turned off by invoking the TONE OFF command. The tone outputs, namely BZ and $\overline{BZ}$, are a pair of differential driving outputs used to drive a piezo buzzer. Once the system is disabled or the tone output is inhibited, the BZ and the $\overline{BZ}$ outputs will remain at low level.

Command Format

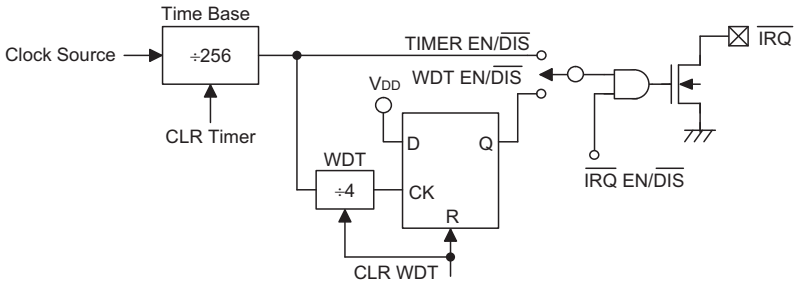
The HT1660 can be configured by software setting. There are two mode commands to configure the HT1660 resource and to transfer the LCD display data.

The configuration mode of the HT1660 is called command mode, and its command mode ID is 100. The command mode consists of a system configuration command, a system frequency selection command, an LCD configuration command, a tone frequency selection command, a bias current selection command, a timer/WDT setting command, and an operating command. The data mode, on the other hand, includes READ, WRITE, and READ-MODIFY-WRITE operations.

The following are the data mode ID and the command mode ID:

Operation	Mode	ID
READ	Data	110
WRITE	Data	101
READ-MODIFY-WRITE	Data	101
COMMAND	Command	100

If successive commands have been issued, the command mode ID can be omitted. While the system is operating in the non-successive command or the non-successive address data mode, the $\overline{CS}$ pin should be set to ″1″ and the previous operation mode will also be reset. The $\overline{CS}$ pin returns to ″0″, so a new operation mode ID should be issued first.



Time Base and WDT Configurations

Name	Command Code	Function
TONE OFF	**X100**-0000-1000-XXXX	Turn-off tone output
TONE 4K	**X100**-0001-0000-XXXX	Turn-on tone output, tone frequency is 4kHz
TONE 2K	**X100**-0001-0001-XXXX	Turn-on tone output, tone frequency is 2kHz

Buzzer Tone Output Command Code

The following are the data mode ID and the command ID:

Operation	Mode	ID
READ	Data	110
WRITE	Data	101
READ-MODIFY-WRITE	Data	101
COMMAND	Command	100

If successive commands have been issued, the command mode ID can be omitted. While the system is operating in the non-successive address data mode, the $\overline{CS}$ pin should be set 1 and the previous operation mode will also be reset. The $\overline{CS}$ pin returns to 0, so a new operation mode ID should be issued first.

Bias Generator

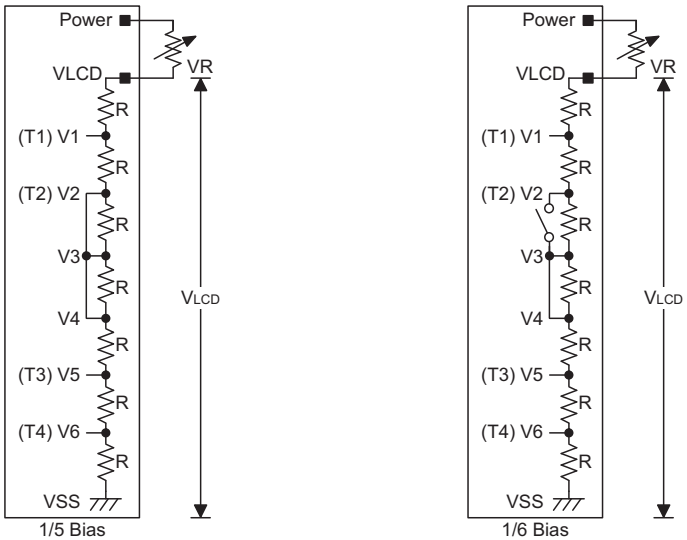
The HT1660 bias voltage belongs to internal resistor type. It provides two kinds of bias option named 1/6 bias and 1/5 bias respectively. It also provides three kinds of bias current option by programming to suitably drive an LCD panel. The three kinds of bias current are large, middle, and small, respectively. Usually, large panel LCD can be excellently displayed by large bias current. Relatively, it consumes large current when LCD ON command is used. Small bias current provides low power consumption during on condition when the LCD is normally displayed. The following are the reference value table.

When the bias current for LCD is more than Large Bias Current setting. It is recommended to add external circuit to increase driving current.

Interfacing

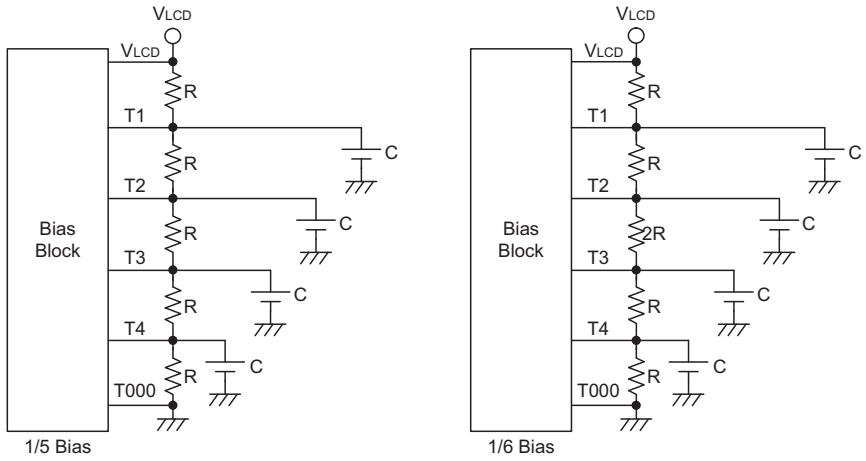
Only six lines are required to interface with the HT1660. The $\overline{CS}$ line is used to initialize the serial interface circuit and to terminate the communication between the host controller and the HT1660. If the $\overline{CS}$ pin is set to 1, the data and command issued between the host controller and the HT1660 are first disabled and then initialized. Before issuing a mode command or mode switching, a high level pulse is required to initialize the serial interface of the HT1660. The DB0~DB3 are the 4-bit parallel data input/output lines. Data to be read or written or commands to be written have to pass through the DB0~DB3 lines. The $\overline{RD}$ line is the READ clock input. Data in the RAM are clocked out on the falling edge of the $\overline{RD}$ signal, and the clocked out data will then appear on the DB0~DB3 lines. It is recommended that the host controller read correct data during the interval between the rising edge and the next falling edge of the $\overline{RD}$ signal. The $\overline{WR}$ line is the WRITE clock input. The data, address, and command on the DB0~DB3 lines are all clocked into the HT1660 on the rising edge of the $\overline{WR}$ signal. There is an optional $\overline{IRQ}$ line to be used as an interface between the host controller and the HT1660. The $\overline{IRQ}$ pin can be selected as a timer output or a WDT overflow flag output by the S/W setting. The host controller can perform the time base or the WDT function by connecting with the $\overline{IRQ}$ pin of the HT1660.

Bias	VLCD	Large Bias Current	Middle Bias Current	Small Bias Current
1/5	3V	165μA	70μA	30μA
	5V	270μA	110μA	50μA
1/6	3V	140μA	55μA	25μA
	5V	225μA	90μA	40μA



Internal Resistor Type Bias Generator Configurations

Note: The voltage applied to V_{LCD} pin must be equal to or lower than 7V.
Adjust VR to fit LCD display.

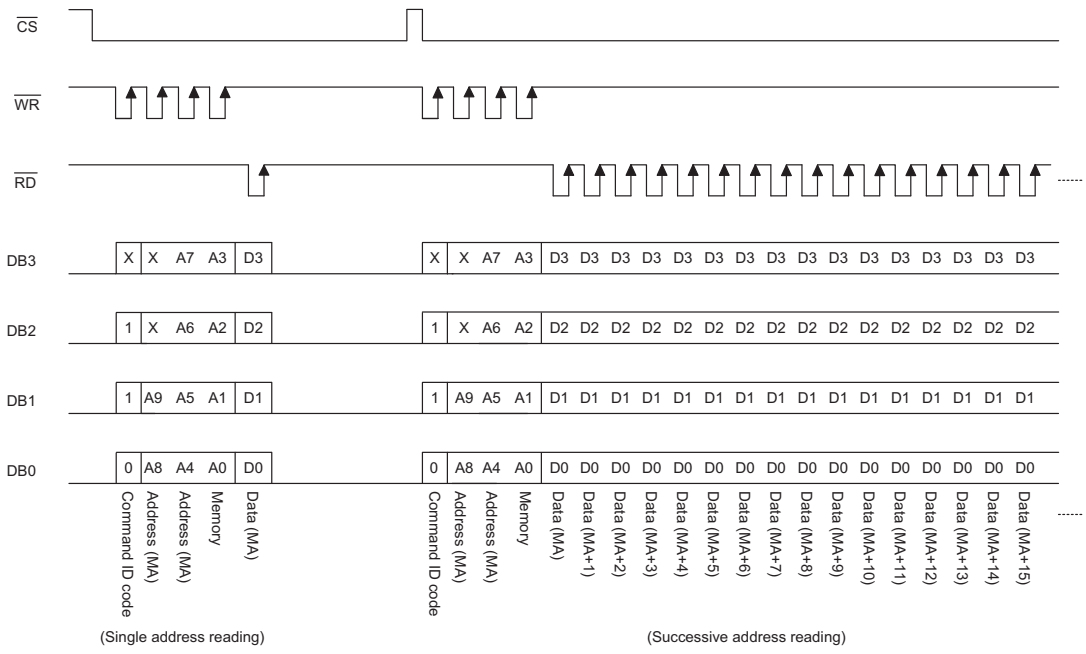


Increase Driver Current Configurations

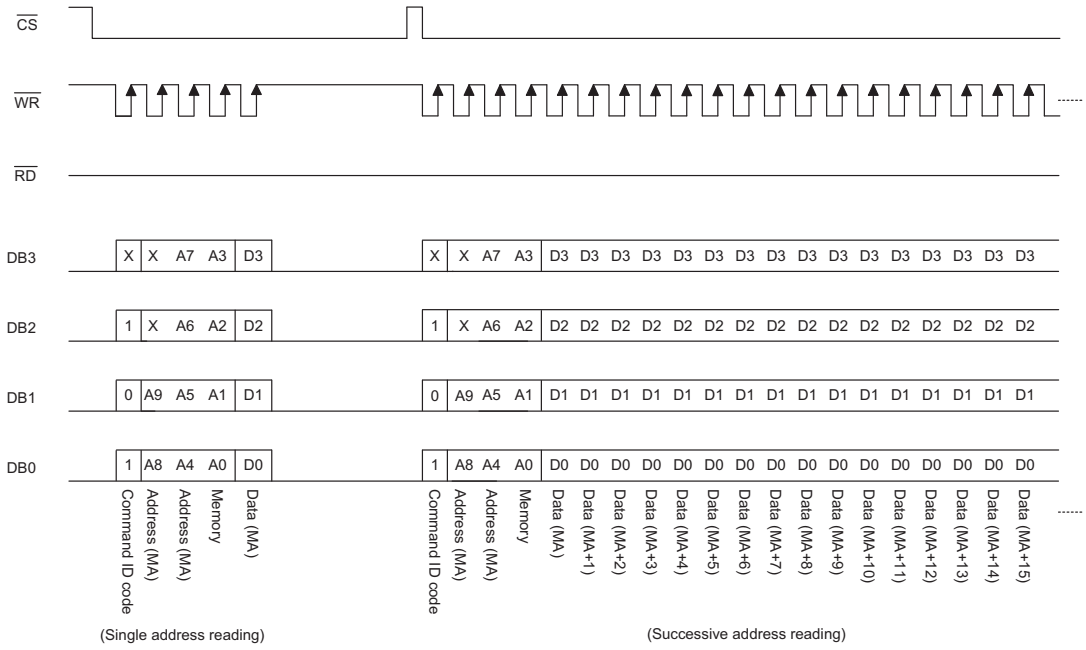
Note: The external resistors are used to increment the driving current.
And the external capacitors are used to keep the bias voltage stable.

Timing Diagrams

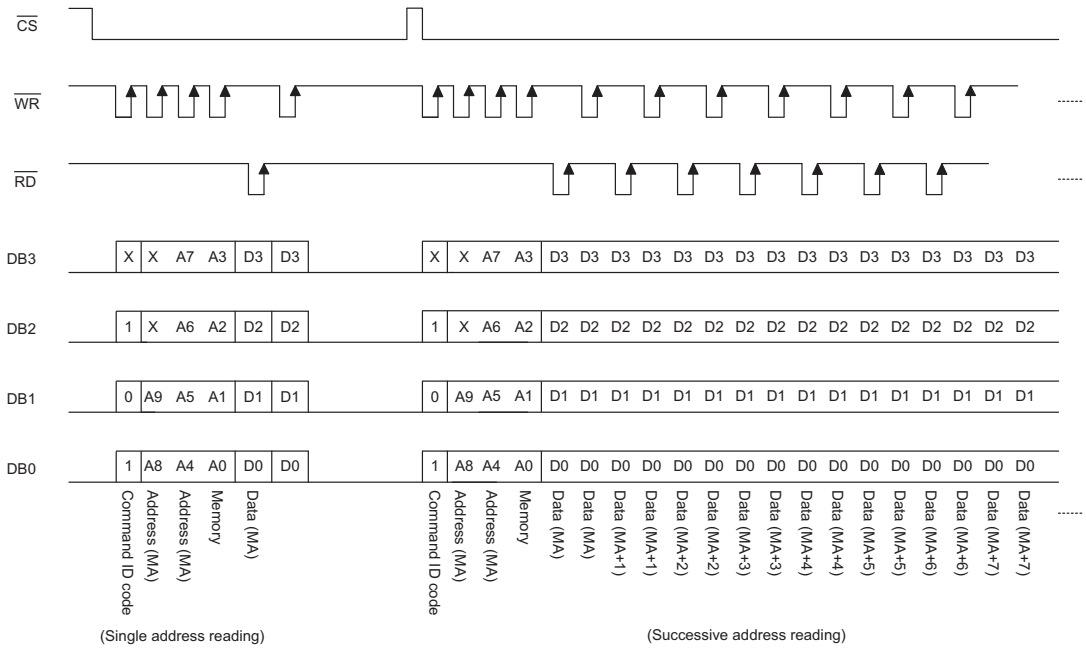
READ Mode (Command ID Code: 1 1 0)



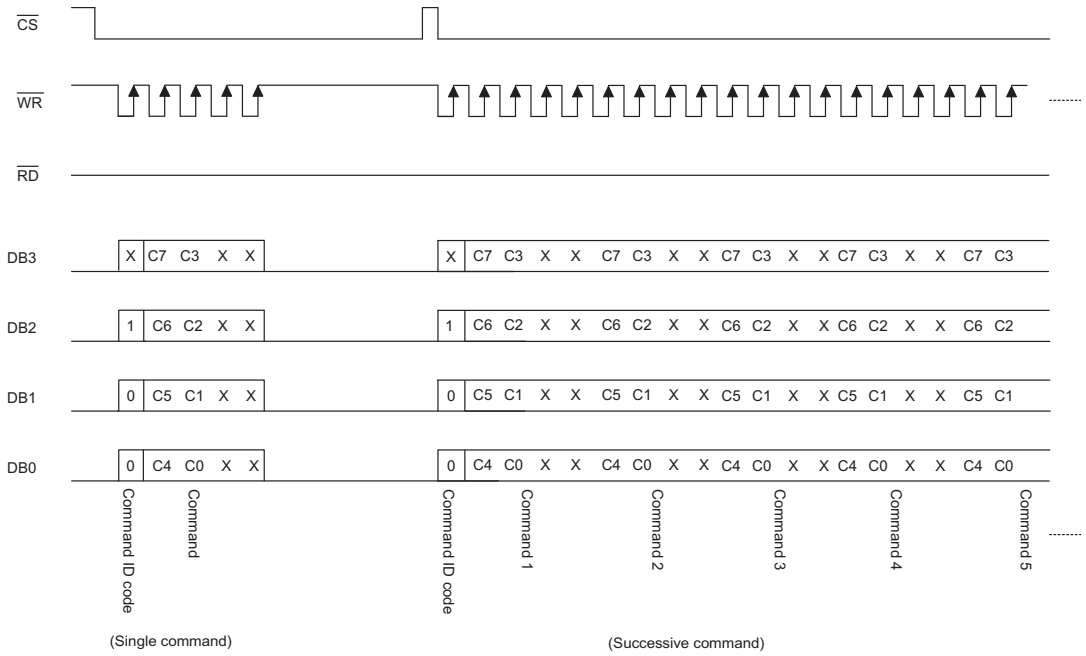
WRITE Mode (Command ID Code: 1 0 1)



READ-MODIFY-WRITE Mode (Command ID Code: 1 0 1)



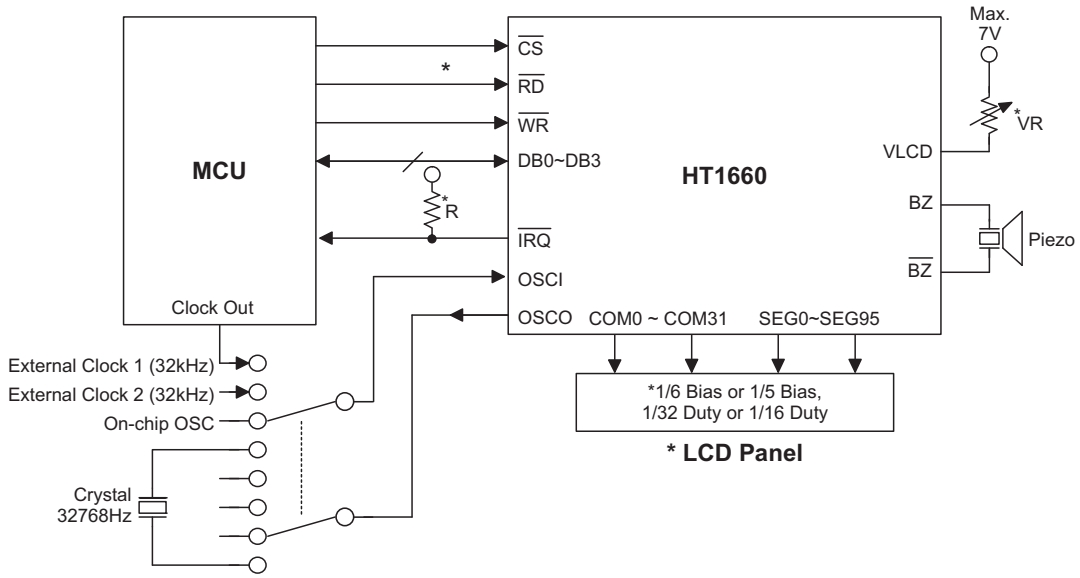
Command Mode (Command ID Code: 1 0 0)



Note: "X" stands for don't care

Application Circuits

Host Controller With an HT1660 Display System



*Note: The connection of $\overline{IRQ}$ and $\overline{RD}$ pin can be selected depending on the MCU.

Adjust VR to fit LCD display

Adjust R (external pull-high resistance) to fit user's time base clock.

It is recommended that the internal equivalent capacitance between SEG and COM of LCD panel should be lower than 10pF. (LCR meter test condition: frequency in 1KHz)

Instruction Set Summary

Name	Command Code	D/C	Function	Def.
READ	X110-XXA9A8-A7A6A5A4-A3A2A1A0-D3D2D1D0	D	Read data from the RAM	
WRITE	X101-XXA9A8-A7A6A5A4-A3A2A1A0-D3D2D1D0	D	Write data to the RAM	
READ-MODIFY-WRITE	X101-XXA9A8-A7A6A5A4-A3A2A1A0-D3D2D1D0	D	Read and Write data to the RAM	
SYS DIS	X100-0000-0000-XXXX-XXXX	C	Turn Off both system oscillator and LCD bias generator	Yes
SYS EN	X100-0000-0001-XXXX-XXXX	C	Turn On system oscillator	
LCD OFF	X100-0000-0010-XXXX-XXXX	C	Turn Off LCD display	Yes
LCD ON	X100-0000-0011-XXXX-XXXX	C	Turn On LCD display	
TIMER DIS	X100-0000-0100-XXXX-XXXX	C	Disable time base output	Yes
WDT DIS	X100-0000-0101-XXXX-XXXX	C	Disable WDT time-out flag output	Yes
TIMER EN	X100-0000-0110-XXXX-XXXX	C	Enable time base output	
WDT EN	X100-0000-0111-XXXX-XXXX	C	Enable WDT time-out flag output	
TONE OFF	X100-0000-1000-XXXX-XXXX	C	Turn Off tone outputs	Yes
CLR TIMER	X100-0000-1101-XXXX-XXXX	C	Clear the contents of the time base generator	
CLR WDT	X100-0000-1111-XXXX-XXXX	C	Clear the contents of the WDT stage	
TONE 4K	X100-0001-0000-XXXX-XXXX	C	Turn on tone output, tone frequency output: 4kHz	
TONE 2K	X100-0001-0001-XXXX-XXXX	C	Turn on tone output, tone frequency output: 2kHz	
IRQ DIS	X100-0001-0010-XXXX-XXXX	C	Disable $\overline{\text{IRQ}}$ output	Yes
IRQ EN	X100-0001-0011-XXXX-XXXX	C	Enable $\overline{\text{IRQ}}$ output	
RC 32K	X100-0001-0100-XXXX-XXXX	C	System clock source, on-chip RC oscillator	Yes
EXT (X′TAL)	X100-0001-0101-XXXX-XXXX	C	System clock source, external 32kHz clock source or crystal oscillator 32.768kHz	
LARGE BIAS	X100-0001-0110-XXXX-XXXX	C	Large bias current option	Yes
MIDDLE BIAS	X100-0001-0111-XXXX-XXXX	C	Middle bias current option	
SMALL BIAS	X100-0001-1000-XXXX-XXXX	C	Small bias current option	
BIAS 1/6	X100-0001-1010-XXXX-XXXX	C	LCD 1/6 bias option	Yes
BIAS 1/5	X100-0001-1001-XXXX-XXXX	C	LCD 1/5 bias option	
FRAME 170Hz	X100-0001-1100-XXXX-XXXX	C	Selects 170Hz frame frequency	
FRAME 89Hz	X100-0001-1101-XXXX-XXXX	C	Selects 89Hz frame frequency	
FRAME 64Hz	X100-0001-1110-XXXX-XXXX	C	Selects 64Hz frame frequency	Yes
Select 112×16	X100-0001-1111-XXXX-XXXX	C	This command will change segment from 96 to 112 and common from 32 to 16	
F1	X100-1010-0000-XXXX-XXXX	C	Time base clock output: 1Hz The WDT time-out flag after: 4s	
F2	X100-1010-0001-XXXX-XXXX	C	Time base clock output: 2Hz The WDT time-out flag after: 2s	
F4	X100-1010-0010-XXXX-XXXX	C	Time base clock output: 4Hz The WDT time-out flag after: 1s	

Name	Command Code	D/C	Function	Def.
F8	X100-1010-0011-XXXX-XXXX	C	Time base clock output: 8Hz The WDT time-out flag after: 1/2s	
F16	X100-1010-0100-XXXX-XXXX	C	Time base clock output: 16Hz The WDT time-out flag after: 1/4s	
F32	X100-1010-0101-XXXX-XXXX	C	Time base clock output: 32Hz The WDT time-out flag after: 1/8s	
F64	X100-1010-0110-XXXX-XXXX	C	Time base clock output: 96Hz The time-out flag after: 1/16s	
F128	X100-1010-0111-XXXX-XXXX	C	Time base clock output: 128Hz The WDT time-out flag after: 1/32s	Yes
TEST	X100-1111-1111-XXXX-XXXX	C	Test mode, user don't use.	
NORMAL	X100-1111-1110-XXXX-XXXX	C	Normal mode, 96×32 mode will be set	Yes

Note: "X" stands for don't care

A9~A0: RAM address

D3~D0: RAM data

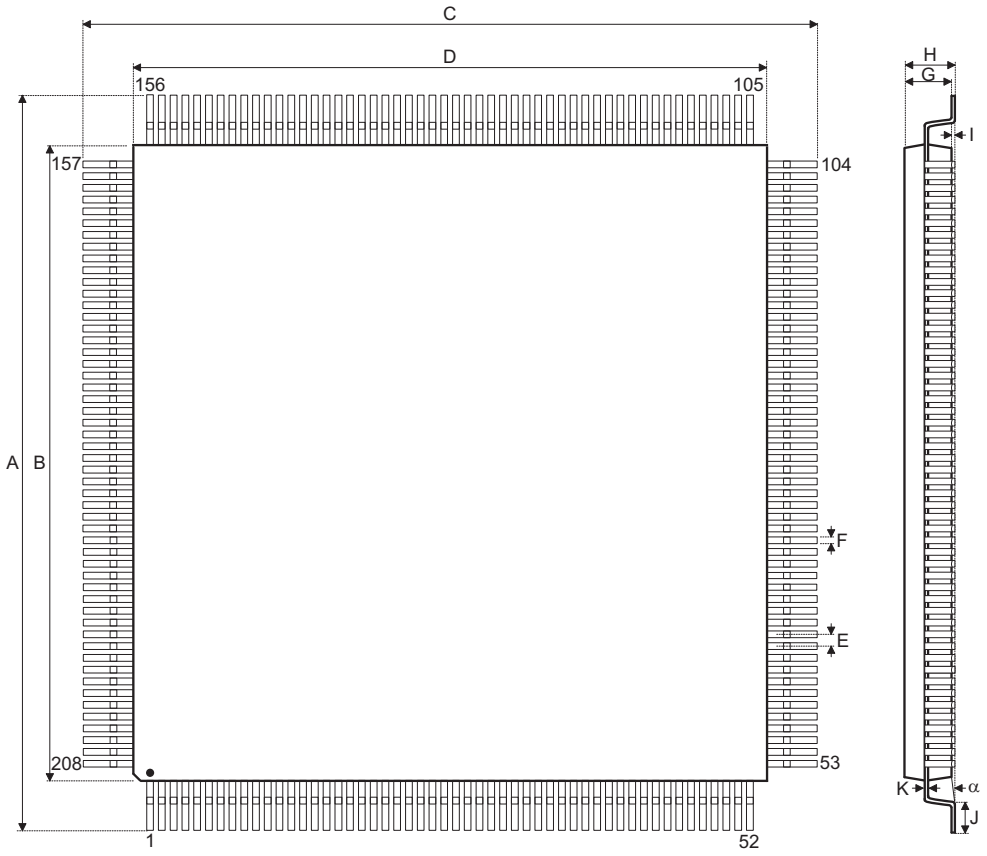
D/C: Data/Command mode

Def.: Power-on reset default

All the bold forms, namely **1 1** 0, **1 0** 1, and **1 0** 0, are mode commands. Of these, **1 0** 0 indicates the command mode ID. If successive commands have been issued, the command mode ID except for the first command will be omitted. The tone frequency source and the time base/WDT clock frequency source can be derived from an on-chip 32kHz RC oscillator, a 32.768kHz crystal oscillator, or an external 32kHz clock. Calculation of the frequency is based on the system frequency sources as stated above. It is recommended that the host controller should initialize the HT1660 after power-on reset, otherwise, power on reset may fail, which in turn leads to the malfunctioning of the HT1660.

Package Information

208-pin QFP (28mm×28mm) Outline Dimensions



Symbol	Dimensions in inch		
	Min.	Nom.	Max.
A	1.220	—	1.236
B	1.098	—	1.106
C	1.220	—	1.236
D	1.098	—	1.106
E	—	0.020	—
F	—	0.008	—
G	0.098	—	0.122
H	—	—	0.134
I	—	0.004	—
J	0.014	—	0.026
K	0.004	—	0.008
α	0°	—	7°

Symbol	Dimensions in mm		
	Min.	Nom.	Max.
A	31.00	—	31.40
B	27.90	—	28.10
C	31.00	—	31.40
D	27.90	—	28.10
E	—	0.50	—
F	—	0.20	—
G	3.10	—	3.40
H	—	—	3.70
I	—	0.10	—
J	0.35	—	0.65
K	0.10	—	0.20
α	0°	—	7°

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